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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	16 x 8
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12ce673-10-p

PIC12C67X

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PIC12C67X

TABLE 1-1: PIC12C67X & PIC12CE67X FAMILY OF DEVICES

		PIC12C671	PIC12LC671	PIC12C672	PIC12LC672	PIC12CE673	PIC12LCE673	PIC12CE674	PIC12LCE674
Clock	Maximum Frequency of Operation (MHz)	10	10	10	10	10	10	10	10
	EPROM Program Memory	1024 x 14	1024 x 14	2048 x 14	2048 x 14	1024 x 14	1024 x 14	2048 x 14	2048 x 14
Memory	RAM Data Memory (bytes)	128	128	128	128	128	128	128	128
	EEPROM Data Memory (bytes)	—	—	—	—	16	16	16	16
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0
	A/D Converter (8-bit) Channels	4	4	4	4	4	4	4	4
	Wake-up from SLEEP on pin change	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Features	Interrupt Sources	4	4	4	4	4	4	4	4
	I/O Pins	5	5	5	5	5	5	5	5
	Input Pins	1	1	1	1	1	1	1	1
	Internal Pull-ups	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
	Number of Instructions	35	35	35	35	35	35	35	35
	Voltage Range (Volts)	3.0V - 5.5V	2.5V - 5.5V	3.0V - 5.5V	2.5V - 5.5V	3.0V - 5.5V	2.5V - 5.5V	3.0V - 5.5V	2.5V - 5.5V
	Packages	8-pin DIP, JW, SOIC	8-pin DIP, JW, SOIC	8-pin DIP, JW, SOIC	8-pin DIP, JW, SOIC	8-pin DIP, JW	8-pin DIP, JW	8-pin DIP, JW	8-pin DIP, JW

All PIC12C67X devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.
All PIC12C67X devices use serial programming with data pin GP0 and clock pin GP1.

PIC12C67X

3.1 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, and the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-2.

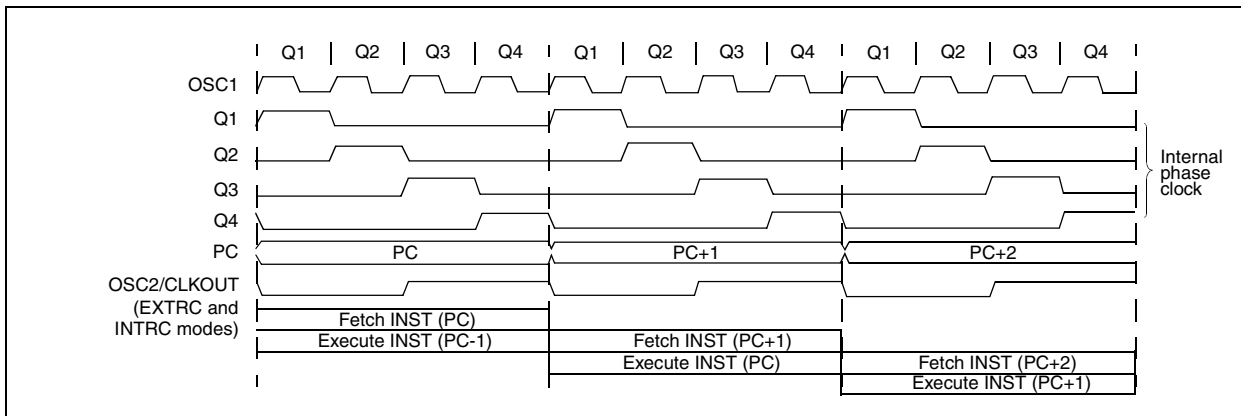
3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (i.e., GOTO), then two cycles are required to complete the instruction (Example 3-1).

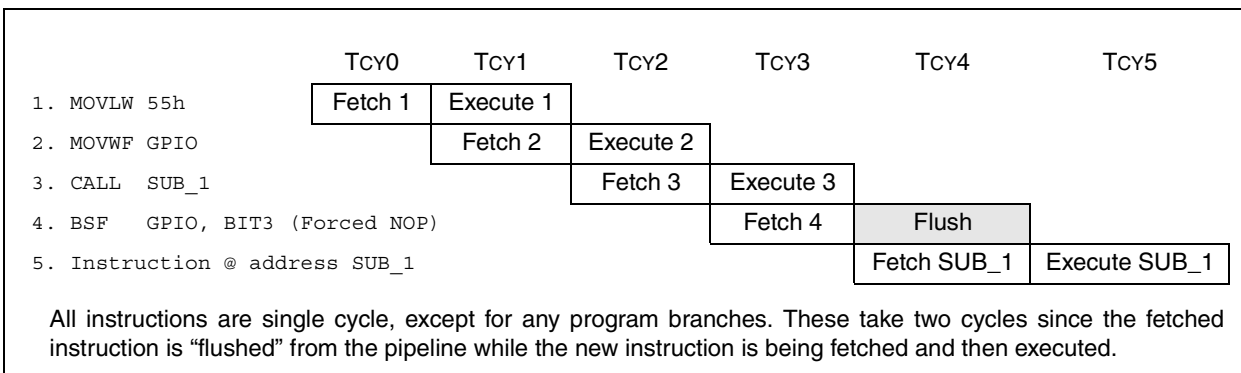
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register" (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



PIC12C67X

FIGURE 4-2: PIC12C67X REGISTER FILE MAP

File Address			File Address
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h
01h	TMR0	OPTION	81h
02h	PCL	PCL	82h
03h	STATUS	STATUS	83h
04h	FSR	FSR	84h
05h	GPIO	TRIS	85h
06h			86h
07h			87h
08h			88h
09h			89h
0Ah	PCLATH	PCLATH	8Ah
0Bh	INTCON	INTCON	8Bh
0Ch	PIR1	PIE1	8Ch
0Dh			8Dh
0Eh		PCON	8Eh
0Fh		OSCCAL	8Fh
10h			90h
11h			91h
12h			92h
13h			93h
14h			94h
15h			95h
16h			96h
17h			97h
18h			98h
19h			99h
1Ah			9Ah
1Bh			9Bh
1Ch			9Ch
1Dh			9Dh
1Eh	ADRES		9Eh
1Fh	ADCON0	ADCON1	9Fh
20h	General Purpose Register	General Purpose Register	A0h
			BFh
			C0h
			EFh
70h		Mapped in Bank 0	F0h
7Fh			FFh
Bank 0		Bank 1	

Unimplemented data memory locations, read as '0'.

Note 1:

Not a physical register.

4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and Peripheral Modules for controlling the desired operation of the device. These registers are implemented as static RAM.

The Special Function Registers can be classified into two sets (core and peripheral). Those registers associated with the “core” functions are described in this section, and those related to the operation of the peripheral features are described in the section of that peripheral feature.

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4.2.2.6 PCON REGISTER

The Power Control (PCON) Register contains a flag bit to allow differentiation between a Power-on Reset (POR), an external $\overline{\text{MCLR}}$ Reset and a WDT Reset.

REGISTER 4-6: PCON REGISTER (ADDRESS 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
—	—	—	—	—	—	POR	—
bit7							bit0

bit 7-2: **Unimplemented:** Read as '0'

bit 1: **$\overline{\text{POR}}$:** Power-on Reset Status bit
1 = No Power-on Reset occurred
0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)

bit 0: **Unimplemented:** Read as '0'

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
- n = Value at POR reset

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NOTES:

TABLE 5-1: SUMMARY OF PORT REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other Resets
85h	TRIS	—	—	GPIO Data Direction Register						--11 1111	--11 1111
81h	OPTION	$\overline{\text{GPPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
03h	STATUS	IRP ⁽¹⁾	RP1 ⁽¹⁾	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	000q quuu
05h	GPIO	SCL ⁽²⁾	SDA ⁽²⁾	GP5	GP4	GP3	GP2	GP1	GP0	11xx xxxx	11uu uuuu

Legend: Shaded cells not used by Port Registers, read as '0', — = unimplemented, read as '0', x = unknown, u = unchanged, q = see tables in Section 9.4 for possible values.

Note 1: The IRP and RP1 bits are reserved on the PIC12C67X; always maintain these bits clear.

2: The SCL and SDA bits are unimplemented on the PIC12C671 and PIC12C672.

5.4 I/O Programming Considerations

5.4.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The *BCF* and *BSF* instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a *BSF* operation on bit5 of GPIO will cause all eight bits of GPIO to be read into the CPU. Then the *BSF* operation takes place on bit5 and GPIO is written to the output latches. If another bit of GPIO is used as a bi-directional I/O pin (i.e., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched to an output, the content of the data latch may now be unknown.

Reading the port register reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (i.e., *BCF*, *BSF*, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-1 shows the effect of two sequential read-modify-write instructions on an I/O port.

EXAMPLE 5-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

```
;Initial GPIO Settings
; GPIO<5:3> Inputs
; GPIO<2:0> Outputs
;
;                                GPIO latch  GPIO pins
;                                -----
BCF  GPIO, 5 ;--01 -ppp  --11 pppp
BCF  GPIO, 4 ;--10 -ppp  --11 pppp
MOVLW 007h ;
TRIS GPIO ;--10 -ppp  --10 pppp
;
;Note that the user may have expected the pin
;values to be --00 pppp. The 2nd BCF caused
;GP5 to be latched as the pin value (High).
```

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

6.5 Read Operations

Read operations are initiated in the same way as write operations with the exception that the R/W bit of the EEPROM address is set to one. There are three basic types of read operations; current address read, random read and sequential read.

6.5.1 CURRENT ADDRESS READ

The EEPROM contains an address counter that maintains the address of the last word accessed, internally incremented by one. Therefore, if the previous read access was to address n , the next current address read operation would access data from address $n + 1$. Upon receipt of the EEPROM address with the R/W bit set to one, the EEPROM issues an acknowledge and transmits the 8-bit data word. The processor will not acknowledge the transfer, but does generate a stop condition and the EEPROM discontinues transmission (Figure 6-8).

6.5.2 RANDOM READ

Random read operations allow the processor to access any memory location in a random manner. To perform this type of read operation, first the word address must be set. This is done by sending the word address to the EEPROM as part of a write operation. After the word

address is sent, the processor generates a start condition following the acknowledge. This terminates the write operation, but not before the internal address pointer is set. Then the processor issues the control byte again, but with the R/W bit set to a one. The EEPROM will then issue an acknowledge and transmits the 8-bit data word. The processor will not acknowledge the transfer, but does generate a stop condition and the EEPROM discontinues transmission (Figure 6-9). After this command, the internal address counter will point to the address location following the one that was just read.

6.5.3 SEQUENTIAL READ

Sequential reads are initiated in the same way as a random read, except that after the device transmits the first data byte, the processor issues an acknowledge as opposed to a stop condition in a random read. This directs the EEPROM to transmit the next sequentially addressed 8-bit word (Figure 6-10).

To provide sequential reads, the EEPROM contains an internal address pointer, which is incremented by one at the completion of each read operation. This address pointer allows the entire memory contents to be serially read during one operation.

FIGURE 6-8: CURRENT ADDRESS READ

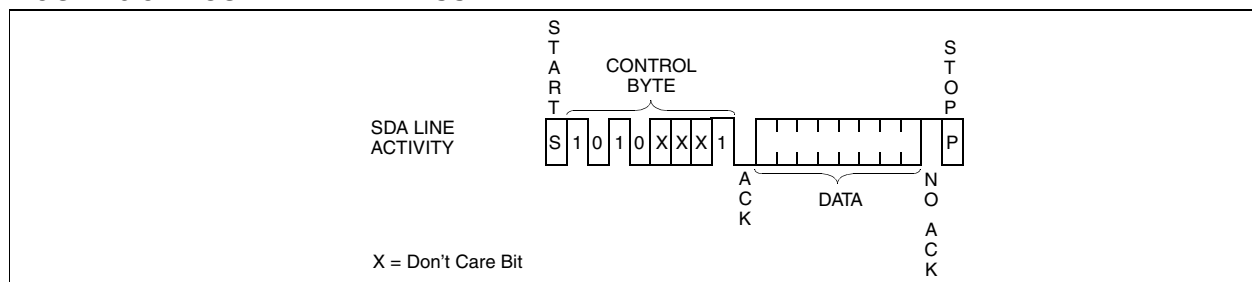


FIGURE 6-9: RANDOM READ

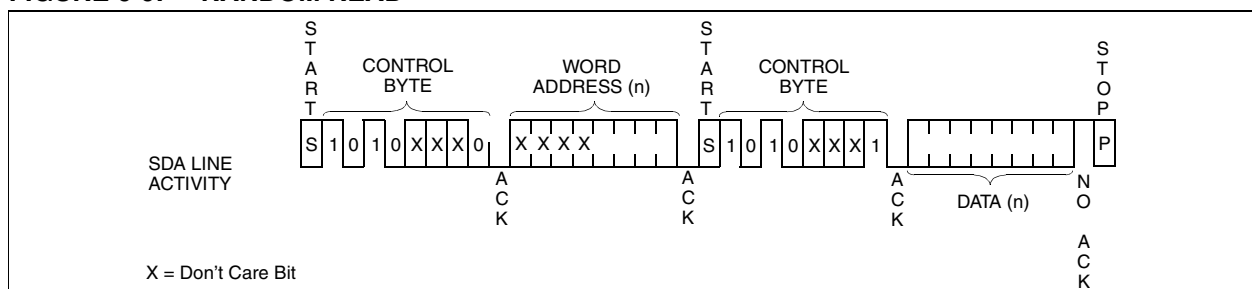
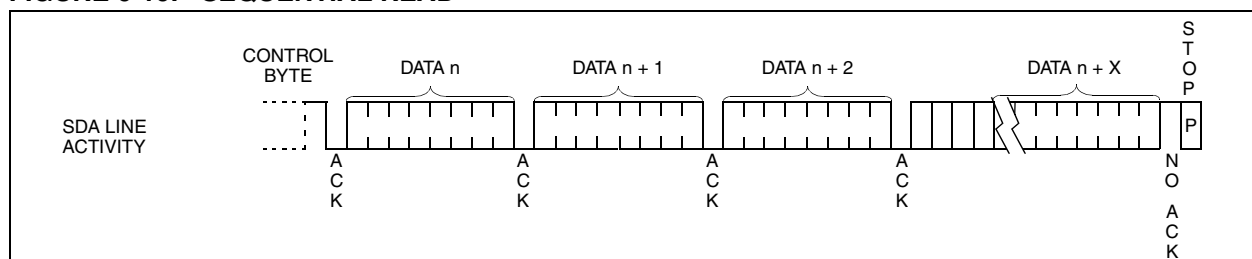


FIGURE 6-10: SEQUENTIAL READ



7.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control, (i.e., it can be changed “on-the-fly” during program execution).

Note: To avoid an unintended device RESET, the following instruction sequence (shown in Example 7-1) must be executed when changing the prescaler assignment from Timer0 to the WDT. This sequence must be followed even if the WDT is disabled.

EXAMPLE 7-1: CHANGING PRESCALER (TIMER0→WDT)

```
BCF    STATUS, RP0    ;Bank 0
CLRF   TMR0           ;Clear TMR0 & Prescaler
BSF    STATUS, RP0    ;Bank 1
CLRWDT           ;Clears WDT
MOVLW  b'xxxx1xxx'    ;Select new prescale
MOVWF  OPTION_REG     ;value & WDT
BCF    STATUS, RP0    ;Bank 0
```

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 7-2.

EXAMPLE 7-2: CHANGING PRESCALER (WDT→TIMER0)

```
CLRWDT           ;Clear WDT and
                  ;prescaler
BSF     STATUS, RP0 ;Bank 1
MOVLW   b'xxx0xxx' ;Select TMR0, new
                  ;prescale value and
MOVWF   OPTION_REG ;clock source
BCF     STATUS, RP0 ;Bank 0
```

TABLE 7-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other Resets
01h	TMR0	Timer0 module's register								xxxx xxxx	uuuu uuuu
0Bh/8Bh	INTCON	GIE	PEIE	TOIE	INTE	GPIE	TOIF	INTF	GPIF	0000 000x	0000 000u
81h	OPTION	GPPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRIS	—	—	TRIS5	TRIS4	TRIS3	TRIS2	TRIS1	TRIS0	--11 1111	--11 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

TABLE 9-6: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	---- --0-
MCLR Reset during normal operation	000h	000u uuuu	---- --u-
MCLR Reset during SLEEP	000h	0001 0uuu	---- --u-
WDT Reset during normal operation	000h	0000 uuuu	---- --u-
WDT Wake-up from SLEEP	PC + 1	uuu0 0uuu	---- --u-
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	---- --u-

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

TABLE 9-7: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Power-on Reset	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	0000 0000	0000 0000	0000 0000
TMR0	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	0000 0000	0000 0000	PC + 1 ⁽²⁾
STATUS	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	xxxx xxxx	uuuu uuuu	uuuu uuuu
GPIO PIC12CE67X	11xx xxxx	11uu uuuu	11uu uuuu
GPIO PIC12C67X	--xx xxxx	--uu uuuu	--uu uuuu
PCLATH	---0 0000	---0 0000	---u uuuu
INTCON	0000 000x	0000 000u	uuuu uqqq ⁽¹⁾
PIR1	-0-- ----	-0-- ----	-q-- ---- ⁽⁴⁾
ADCON0	0000 0000	0000 0000	uuuu uquu ⁽⁵⁾
OPTION	1111 1111	1111 1111	uuuu uuuu
TRIS	--11 1111	--11 1111	--uu uuuu
PIE1	-0-- ----	-0-- ----	-u-- ----
PCON	---- --0-	---- --u-	---- --u-
OSCCAL	0111 00--	uuuu uu--	uuuu uu--
ADCON1	---- -000	---- -000	---- -uuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition.

Note 1: One or more bits in INTCON and PIR1 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 9-5 for reset value for specific condition.

4: If wake-up was due to A/D completing then bit 6 = 1, all other interrupts generating a wake-up will cause bit 6 = u.

5: If wake-up was due to A/D completing then bit 3 = 0, all other interrupts generating a wake-up will cause bit 3 = u.

FIGURE 9-10: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)

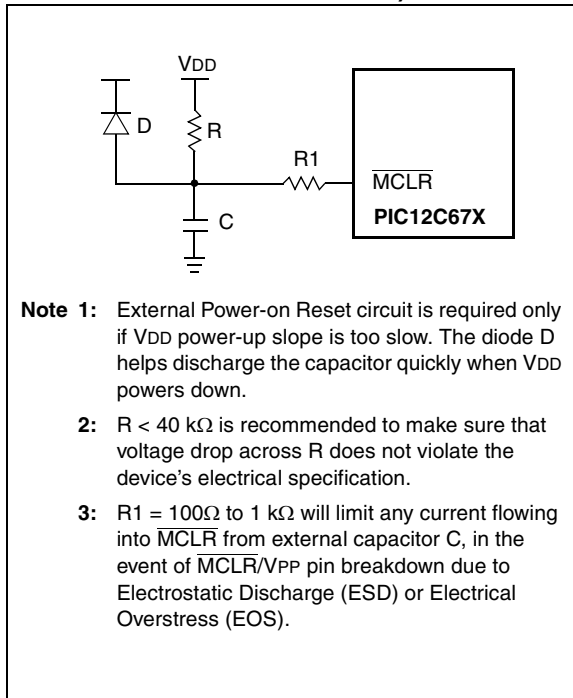


FIGURE 9-11: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1

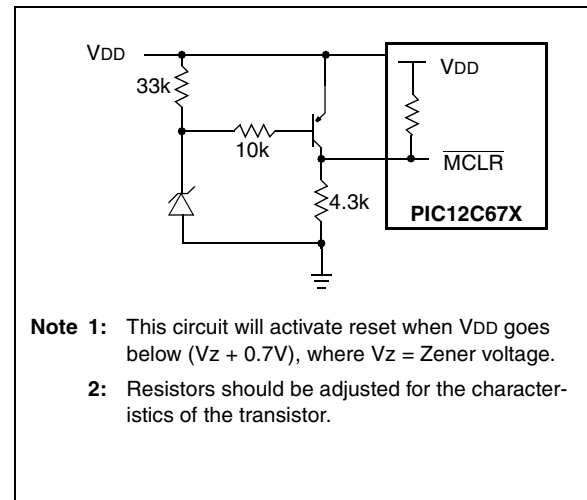


FIGURE 9-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2

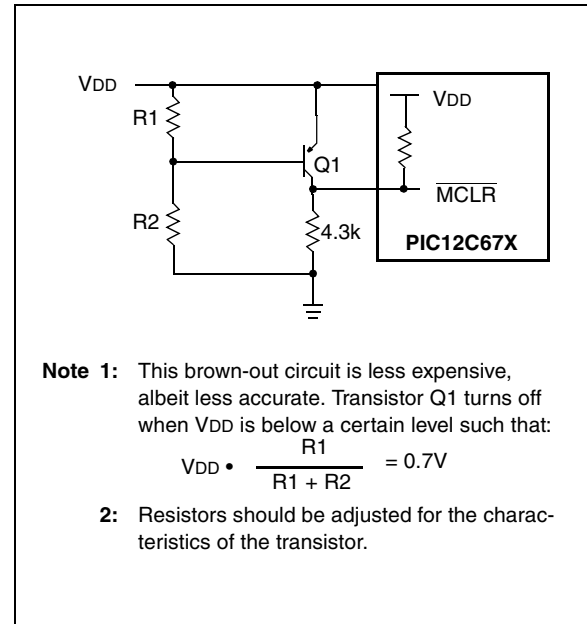


TABLE 10-2: INSTRUCTION SET SUMMARY

Mnemonic, Operands	Description	Cycles	14-Bit Opcode				Status Affected	Notes	
			MSb		LSb				
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	00	0001	1fff	ffff	Z	2
CLRWF	-	Clear W	1	00	0001	0000	0011	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	1fff	ffff		
NOP	-	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	C	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	C	1,2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
LITERAL AND CONTROL OPERATIONS									
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}, \overline{PD}$	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	-	Go into standby mode	1	00	0000	0110	0011	$\overline{TO}, \overline{PD}$	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (i.e., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.

PIC12C67X

10.2 Instruction Descriptions

ADDLW Add Literal and W

Syntax: [*label*] ADDLW *k*

Operands: $0 \leq k \leq 255$

Operation: $(W) + k \rightarrow (W)$

Status Affected: C, DC, Z

Encoding:

11	111x	kkkk	kkkk
----	------	------	------

Description: The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.

Words: 1

Cycles: 1

Example ADDLW 0x15

Before Instruction
W = 0x10
After Instruction
W = 0x25

ANDLW And Literal with W

Syntax: [*label*] ANDLW *k*

Operands: $0 \leq k \leq 255$

Operation: $(W) .AND. (k) \rightarrow (W)$

Status Affected: Z

Encoding:

11	1001	kkkk	kkkk
----	------	------	------

Description: The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Example ANDLW 0x5F

Before Instruction
W = 0xA3
After Instruction
W = 0x03

ADDWF Add W and f

Syntax: [*label*] ADDWF *f,d*

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) + (f) \rightarrow (\text{dest})$

Status Affected: C, DC, Z

Encoding:

00	0111	dfff	ffff
----	------	------	------

Description: Add the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example ADDWF FSR, 0

Before Instruction
W = 0x17
FSR = 0xC2
After Instruction
W = 0xD9
FSR = 0xC2

ANDWF AND W with f

Syntax: [*label*] ANDWF *f,d*

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) .AND. (f) \rightarrow (\text{dest})$

Status Affected: Z

Encoding:

00	0101	dfff	ffff
----	------	------	------

Description: AND the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

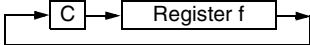
Words: 1

Cycles: 1

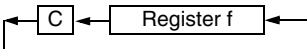
Example ANDWF FSR, 1

Before Instruction
W = 0x17
FSR = 0xC2
After Instruction
W = 0x17
FSR = 0x02

RETURN		Return from Subroutine						
Syntax:	[<i>label</i>] RETURN							
Operands:	None							
Operation:	TOS → PC							
Status Affected:	None							
Encoding:	<table border="1"><tr><td>00</td><td>0000</td><td>0000</td><td>1000</td></tr></table>				00	0000	0000	1000
00	0000	0000	1000					
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction.							
Words:	1							
Cycles:	2							
Example	RETURN							
	After Interrupt							
	PC = TOS							

RRF		Rotate Right f through Carry							
Syntax:	[<i>label</i>] RRF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	See description below								
Status Affected:	C								
Encoding:	<table border="1"><tr><td>00</td><td>1100</td><td>dfff</td><td>ffff</td></tr></table>					00	1100	dfff	ffff
00	1100	dfff	ffff						
Description:	<p>The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.</p> 								
Words:	1								
Cycles:	1								
Example	RRF								

Before Instruction
REG1 = 1110 0110
C = 0
After Instruction
REG1 = 1110 0110
W = 0111 0011
C = 0

RLF		Rotate Left f through Carry							
Syntax:	[<i>label</i>] RLF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	See description below								
Status Affected:	C								
Encoding:	<table><tr><td>00</td><td>1101</td><td>dfff</td><td>ffff</td></tr></table>					00	1101	dfff	ffff
00	1101	dfff	ffff						
Description:	<p>The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.</p> <div></div>								
Words:	1								
Cycles:	1								
Example	RLF REG1, 0								
Before Instruction									
REG1 = 1110 0110									
C = 0									
After Instruction									
REG1 = 1110 0110									
W = 1100 1100									
C = 1									

SLEEP					
Syntax:	[<i>label</i>] SLEEP				
Operands:	None				
Operation:	00h → WDT, 0 → WDT prescaler, 1 → <u>TO</u> , 0 → PD				
Status Affected:	<u>TO</u> , <u>PD</u>				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0011</td></tr></table>	00	0000	0110	0011
00	0000	0110	0011		
Description:	The power-down status bit, <u>PD</u> is cleared. Time-out status bit, <u>TO</u> is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped.				
Words:	1				
Cycles:	1				
Example:	SLEEP				

12.0 ELECTRICAL SPECIFICATIONS FOR PIC12C67X

Absolute Maximum Ratings †

Ambient temperature under bias	–40° to +125°C
Storage temperature	–65°C to +150°C
Voltage on any pin with respect to VSS (except VDD and $\overline{\text{MCLR}}$).....	–0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	0 to +7.0V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS (Note 2).....	0 to +14V
Total power dissipation (Note 1).....	700 mW
Maximum current out of VSS pin	200 mA
Maximum current into VDD pin	150 mA
Input clamp current, I _{IK} (V _I < 0 or V _I > VDD).....	± 20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > VDD)	± 20 mA
Maximum output current sunk by any I/O pin.....	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by GPIO pins combined	100 mA
Maximum current sourced by GPIO pins combined.....	100 mA

Note 1: Power dissipation is calculated as follows: $P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)					
Parm No.	Characteristic	Sym	Min	Typ ⁽¹⁾	Max	Units	Conditions
	LP Oscillator Operating Frequency	FOSC	0		200	kHz	All temperatures
	INTRC/EXTRC Oscillator Operating Frequency		—		4 ⁽⁶⁾	MHz	All temperatures
	XT Oscillator Operating Frequency		0		4	MHz	All temperatures
	HS Oscillator Operating Frequency		0		10	MHz	All temperatures

* These parameters are characterized but not tested.

- Note 1:** Data in Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
- 2:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
- 3:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
- a) The test conditions for all IDD measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD,
MCLR = VDD; WDT disabled.
- b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
- 4:** For EXTRC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula:
 $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in kOhm.
- 5:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.
- 6:** INTRC calibration value is for 4MHz nominal at 5V, 25°C.

TABLE 12-2: CALIBRATED INTERNAL RC FREQUENCIES -PIC12C671, PIC12C672, PIC12CE673, PIC12CE674, PIC12LC671, PIC12LC672, PIC12LCE673, PIC12LCE674

AC Characteristics		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial), $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial), $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)					
		Operating Voltage V_{DD} range is described in Section 10.1					
Parameter No.	Sym	Characteristic	Min*	Typ ⁽¹⁾	Max*	Units	Conditions
		Internal Calibrated RC Frequency	3.65	4.00	4.28	MHz	$V_{DD} = 5.0\text{V}$
		Internal Calibrated RC Frequency	3.55	4.00	4.31	MHz	$V_{DD} = 2.5\text{V}$

* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 12-9: EEPROM MEMORY BUS TIMING REQUIREMENTS - PIC12CE673/674 ONLY.

AC Characteristics		Standard Operating Conditions (unless otherwise specified)			
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$, $V_{CC} = 3.0\text{V}$ to 5.5V (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$, $V_{CC} = 3.0\text{V}$ to 5.5V (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$, $V_{CC} = 4.5\text{V}$ to 5.5V (extended) Operating Voltage V_{DD} range is described in Section 12.1			
Parameter	Symbol	Min	Max	Units	Conditions
Clock frequency	FCLK	— — —	100 100 400	kHz	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Clock high time	T _{HIGH}	4000 4000 600	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Clock low time	T _{LOW}	4700 4700 1300	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
SDA and SCL rise time (Note 1)	T _R	— — —	1000 1000 300	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
SDA and SCL fall time	T _F	—	300	ns	(Note 1)
START condition hold time	T _{HD:STA}	4000 4000 600	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
START condition setup time	T _{SU:STA}	4700 4700 600	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Data input hold time	T _{HD:DAT}	0	—	ns	(Note 2)
Data input setup time	T _{SU:DAT}	250 250 100	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
STOP condition setup time	T _{SU:STO}	4000 4000 600	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Output valid from clock (Note 2)	T _{AA}	— — —	3500 3500 900	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Bus free time: Time the bus must be free before a new transmis- sion can start	T _{BUF}	4700 4700 1300	— — —	ns	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ (E Temp range) $3.0\text{V} \leq V_{CC} \leq 4.5\text{V}$ $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$
Output fall time from V _{IH} minimum to V _{IL} maximum	T _{OF}	20+0.1 CB	250	ns	(Note 1), $C_B \leq 100\text{ pF}$
Input filter spike suppression (SDA and SCL pins)	T _{SP}	—	50	ns	(Notes 1, 3)
Write cycle time	T _{WC}	—	4	ms	
Endurance		1M	—	cycles	25°C, $V_{CC} = 5.0\text{V}$, Block Mode (Note 4)

Note 1: Not 100% tested. C_B = total capacitance of one bus line in pF.

2: As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL and avoid unintended generation of START or STOP conditions.

3: The combined T_{SP} and V_{HYS} specifications are due to new Schmitt Trigger inputs which provide improved noise spike suppression. This eliminates the need for a T_I specification for standard operation.

4: This parameter is not tested but ensured by characterization. For endurance estimates in a specific application, please consult the Total Endurance Model which can be obtained on Microchip's website.

PIC12C67X

NOTES:

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